TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# **TC74VCX16373FT**

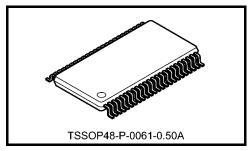
#### Low-Voltage 16-Bit D-Type Latch with 3.6-V Tolerant Inputs and Outputs

The TC74VCX16373FT is a high-performance CMOS 16-bit D-type latch. Designed for use in 1.8-V, 2.5-V or 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

It is also designed with overvoltage tolerant inputs and outputs up to  $3.6\ V$ .

This 16-bit D-type latch is controlled by a latch enable input (LE) and an output enable input  $(\overline{OE})$  which are common to each byte. It can be used as two 8-bit latches or one 16-bit latch. When the  $\overline{OE}$  input is high, the outputs are in a high-impedance state.

All inputs are equipped with protection circuits against static discharge.



Weight: 0.25 g (typ.)

#### **Features**

- Low-voltage operation: V<sub>CC</sub> = 1.8 to 3.6 V
- High-speed operation:  $t_{pd} = 3.0 \text{ ns (max) (V}_{CC} = 3.0 \text{ to } 3.6 \text{ V)}$

:  $t_{pd} = 3.4 \text{ ns (max) (V}_{CC} = 2.3 \text{ to } 2.7 \text{ V})$ 

:  $t_{pd} = 5.7 \text{ ns (max) (V}_{CC} = 1.8 \text{ V})$ 

• Output current:  $I_{OH}/I_{OL} = \pm 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$ 

:  $I_{OH}/I_{OL} = \pm 18 \text{ mA (min) (V}_{CC} = 2.3 \text{ V)}$ 

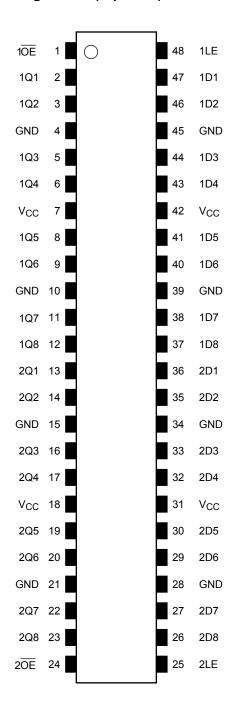
:  $I_{OH}/I_{OL} = \pm 6 \text{ mA (min) (V}_{CC} = 1.8 \text{ V)}$ 

- Latch-up performance: -300 mA
- ESD performance: Machine model  $\geq \pm 200 \text{ V}$

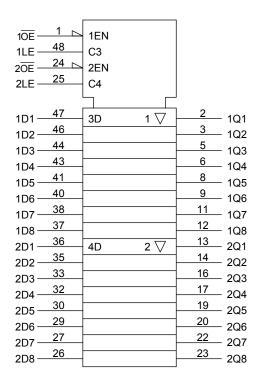
Human body model  $\geq \pm 2000 \text{ V}$ 

- Package: TSSOP
- 3.6-V tolerant function and power-down protection provided on all inputs and outputs

### Pin Assignment (top view)



### **IEC Logic Symbol**



#### **Truth Table**

	Outputs		
1OE	1LE	1D1-1D8	1Q1-1Q8
Н	Х	Х	Z
L	L	Х	Qn
L	Н	L	L
L	Н	Н	Н

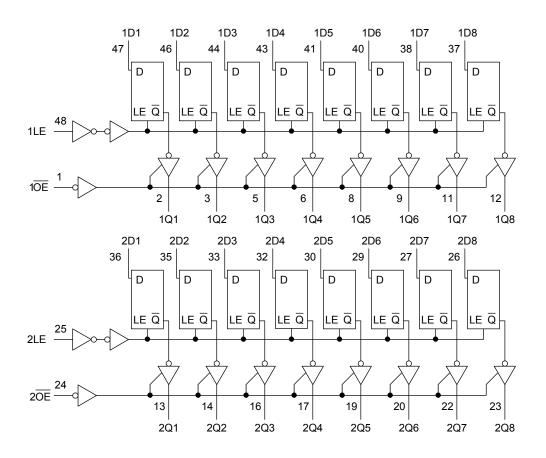
	Outputs		
2 <del>OE</del>	2LE	2D1-2D8	2Q1-2Q8
Н	Х	Х	Z
L	L	Х	Qn
L	Н	L	L
L	Н	Н	Н

X: Don't care

Z: High impedance

Qn: Q outputs are latched at the time when the LE input is taken to a low logic level.

### **System Diagram**



#### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit	
Power supply voltage	V <sub>CC</sub>	-0.5 to 4.6	V	
DC input voltage	V <sub>IN</sub>	-0.5 to 4.6	V	
		-0.5 to 4.6 (Note 2)		
DC output voltage	V <sub>OUT</sub>	$-0.5 \text{ to V}_{CC} + 0.5$ (Note 3)	V	
Input diode current	l <sub>IK</sub>	-50	mA	
Output diode current	I <sub>OK</sub>	±50 (Note 4)	mA	
DC output current	lout	±50	mA	
Power dissipation	$P_{D}$	400	mW	
DC V <sub>CC</sub> /ground current per supply pin	I <sub>CC</sub> /I <sub>GND</sub>	±100	mA	
Storage temperature	T <sub>stg</sub>	-65 to 150	°C	

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: OFF state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: Vout < GND, Vout > Vcc

### **Operating Ranges (Note 1)**

Characteristics	Symbol	Rating	Unit
Power supply voltage	Vac	1.8 to 3.6	V
Fower supply voltage	V <sub>CC</sub>	1.2 to 3.6 (Note 2)	V
Input voltage	V <sub>IN</sub>	-0.3 to 3.6	V
Output voltage	V	0 to 3.6 (Note 3)	V
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub> (Note 4)	V
		±24 (Note 5)	
Output current	I <sub>OH</sub> /I <sub>OL</sub>	±18 (Note 6)	mA
		±6 (Note 7)	
Operating temperature	T <sub>opr</sub>	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 10 (Note 8)	ns/V

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

Note 2: Data retention only

Note 3: OFF state

Note 4: High or low state Note 5:  $V_{CC} = 3.0$  to 3.6 V Note 6:  $V_{CC} = 2.3$  to 2.7 V

Note 7:  $V_{CC} = 1.8 V$ 

Note 8:  $V_{IN} = 0.8$  to 2.0 V,  $V_{CC} = 3.0$  V



### **Electrical Characteristics**

### DC Characteristics (Ta = -40 to $85^{\circ}$ C, 2.7 V < $V_{CC} \le 3.6$ V)

Characteri	stics	Symbol	Test C	Condition	V <sub>CC</sub> (V)	Min	Max	Unit
	H-level	V <sub>IH</sub>	-	_	2.7 to 3.6	2.0	_	.,
Input voltage	L-level	V <sub>IL</sub>	-	_	2.7 to 3.6	_	0.8	V
				I <sub>OH</sub> = -100 μA	2.7 to 3.6	V <sub>CC</sub> - 0.2	_	
	H-level	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -12 mA	2.7	2.2	_	
				I <sub>OH</sub> = -18 mA	3.0	2.4	_	
Output voltage				I <sub>OH</sub> = -24 mA	3.0	2.2	_	V
		V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 100 μA	2.7 to 3.6	_	0.2	
	L-level			I <sub>OL</sub> = 12 mA	2.7	_	0.4	
	L-level			I <sub>OL</sub> = 18 mA	3.0	_	0.4	
				$I_{OL} = 24 \text{ mA}$	3.0	_	0.55	
Input leakage curre	nt	I <sub>IN</sub>	V <sub>IN</sub> = 0 to 3.6 V		2.7 to 3.6	_	±5.0	μА
3-state output OFF state current		I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = 0 to 3.6 V		2.7 to 3.6	_	±10.0	μА
Power-off leakage	current	l <sub>OFF</sub>	V <sub>IN</sub> , V <sub>OUT</sub> = 0 to 3.6 V		0	_	10.0	μА
Quiescent supply current		laa	V <sub>IN</sub> = V <sub>CC</sub> or GND		2.7 to 3.6	_	20.0	
		Icc	V <sub>CC</sub> ≤ (V <sub>IN</sub> , V <sub>OUT</sub> ) ≤ 3.6 V		2.7 to 3.6	_	±20.0	μА
Increase in I <sub>CC</sub> per	input	Δlcc	$V_{IH} = V_{CC} - 0.6 V$		2.7 to 3.6	_	750	

# DC Characteristics (Ta = -40 to 85°C, 2.3 V $\leq$ V<sub>CC</sub> $\leq$ 2.7 V)

Character	istics	Symbol	Test 0	Condition	V <sub>CC</sub> (V)	Min	Max	Unit
Innut voltage	H-level	V <sub>IH</sub>		_	2.3 to 2.7	1.6	_	V
Input voltage	L-level	V <sub>IL</sub>		_	2.3 to 2.7	_	0.7	V
				I <sub>OH</sub> = -100 μA	2.3 to 2.7	V <sub>CC</sub> - 0.2	_	
	H-level	VoH	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	$I_{OH} = -6 \text{ mA}$	2.3	2.0	_	
Output voltage	011		I <sub>OH</sub> = -12 mA	2.3	1.8	_		
				I <sub>OH</sub> = -18 mA	2.3	1.7	_	V
			$V_{IN} = V_{IH}$ or $V_{IL}$	I <sub>OL</sub> = 100 μA	2.3 to 2.7	_	0.2	
	L-level	V <sub>OL</sub>		I <sub>OL</sub> = 12 mA	2.3	_	0.4	
				I <sub>OL</sub> = 18 mA	2.3	_	0.6	
Input leakage curre	ent	I <sub>IN</sub>	V <sub>IN</sub> = 0 to 3.6 V	•	2.3 to 2.7	_	±5.0	μА
3-state output OFF	state current	I <sub>OZ</sub>	$V_{IN} = V_{IH}$ or $V_{IL}$ $V_{OUT} = 0$ to 3.6 V		2.3 to 2.7	_	±10.0	μА
Power-off leakage	current	loff	$V_{IN}$ , $V_{OUT} = 0$ to 3.6 V		0	_	10.0	μА
Quiescent supply current			V <sub>IN</sub> = V <sub>CC</sub> or GND		2.3 to 2.7	_	20.0	^
Quiescerit supply t	uncni	Icc	$V_{CC} \le (V_{IN}, V_{OUT}) \le 3$	V <sub>CC</sub> ≤ (V <sub>IN</sub> , V <sub>OUT</sub> ) ≤ 3.6 V		_	±20.0	μА



# DC Characteristics (Ta = -40 to 85°C, 1.8 V $\leq$ V<sub>CC</sub> < 2.3 V)

Characteristics		Symbol	Test Co	ondition		Min	Max	Unit
Ondracteris	51103	Cymbol	1631 00	rest donation		IVIIII	IVIGA	Offic
Input voltage	H-level	V <sub>IH</sub>	_	_	1.8 to 2.3	$^{0.7\times}_{\text{CC}}$		V
input voltage	L-level	V <sub>IL</sub>	_	_	1.8 to 2.3	_	0.2 × V <sub>CC</sub>	V
	H-level	Voh	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	$I_{OH} = -100 \mu A$	1.8	V <sub>CC</sub> - 0.2		
Output voltage				$I_{OH} = -6 \text{ mA}$	1.8	1.4		V
	L-level	V <sub>OL</sub>	$V_{IN} = V_{IH}$ or $V_{IL}$	$I_{OL} = 100 \mu A$	1.8	_	0.2	
	L-IEVEI	VOL		I <sub>OL</sub> = 6 mA	1.8	_	0.3	
Input leakage currer	nt	I <sub>IN</sub>	$V_{IN} = 0$ to 3.6 V		1.8	_	±5.0	μΑ
3-state output OFF state current I <sub>OZ</sub>		l <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = 0 to 3.6 V		1.8	_	±10.0	μА
Power-off leakage c	urrent	l <sub>OFF</sub>	V <sub>IN</sub> , V <sub>OUT</sub> = 0 to 3.6 V		0	_	10.0	μА
Quiescent supply current		loo	V <sub>IN</sub> = V <sub>CC</sub> or GND		1.8	_	20.0	μА
Quiescent supply cu	ii i Gill	Icc	V <sub>CC</sub> ≤ (V <sub>IN</sub> , V <sub>OUT</sub> ) ≤ 3.6 V		1.8	_	±20.0	μΑ

# AC Characteristics (Ta = –40 to 85°C, input: $t_r = t_f$ = 2.0 ns, $C_L$ = 30 pF, $R_L$ = 500 $\Omega$ ) (Note 1)

Characteristics	Symbol	Symbol Test Condition		Min		Unit
Characteristics	Syllibol	rest Condition	V <sub>CC</sub> (V)	IVIIII	Max	Offic
Propagation delay time	<b></b>		1.8	1.5	5.7	
(D-Q)	t <sub>pLH</sub> t <sub>pHL</sub>	Figure 1, Figure 2	$2.5 \pm 0.2$	1.0	3.4	ns
(D-Q)	фнг		$3.3 \pm 0.3$	8.0	3.0	
Dronagation dalay time	4		1.8	1.5	6.0	
Propagation delay time (LE-Q)	t <sub>pLH</sub>	Figure 1, Figure 2	$2.5 \pm 0.2$	1.0	3.9	ns
(LL-Q)	t <sub>pHL</sub>		$3.3 \pm 0.3$	8.0	3.0	
	4		1.8	1.5	7.0	
3-state output enable time	t <sub>pZL</sub>	Figure 1, Figure 3	$2.5 \pm 0.2$	1.0	4.6	ns
	t <sub>pZH</sub>		$3.3 \pm 0.3$	8.0	3.5	
	4	Figure 1, Figure 3	1.8	1.5	5.0	
3-state output disable time	t <sub>pLZ</sub>		$2.5 \pm 0.2$	1.0	3.8	ns
			$3.3 \pm 0.3$	8.0	3.5	
Minimum nulae width		Figure 1, Figure 2	1.8	3.0	-	
Minimum pulse width (LE)	t <sub>w (H)</sub>		$2.5 \pm 0.2$	1.5	_	ns
(LL)			$3.3 \pm 0.3$	1.5	_	
			1.8	2.5	_	
Minimum setup time	ts	Figure 1, Figure 2	$2.5 \pm 0.2$	1.5	_	ns
			$3.3 \pm 0.3$	1.5	_	
			1.8	1.0	_	
Minimum hold time	t <sub>h</sub>	Figure 1, Figure 2	$2.5\pm0.2$	1.0	_	ns
			$3.3 \pm 0.3$	1.0	_	
			1.8	_	0.5	
Output to output skew	t <sub>osLH</sub>	(Note 2)	$2.5\pm0.2$	_	0.5	ns
	t <sub>osHL</sub>		$3.3 \pm 0.3$	_	0.5	

Note 1: For  $C_L = 50 \ pF$ , add approximately 300 ps to the AC maximum specification.

Note 2: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{PLHm} - t_{PLHn}|, t_{OSHL} = |t_{PHLm} - t_{PHLn}|)$ 



### Dynamic Switching Characteristics (Ta = 25°C, input: $t_r = t_f = 2.0$ ns, $C_L = 30$ pF)

Characteristics	Symbol	Test Condition			Тур.	Unit
Characteristics	Symbol	rest Contaition		V <sub>CC</sub> (V)	τyp.	Gill
		$V_{IH} = 1.8 \text{ V}, V_{IL} = 0 \text{ V}$ (N	ote)	1.8	0.25	
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>OLP</sub>	$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$ (N	ote)	2.5	0.6	V
		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$ (N	ote)	3.3	0.8	
	V <sub>OLV</sub>	$V_{IH} = 1.8 \text{ V}, V_{IL} = 0 \text{ V}$ (N	ote)	1.8	-0.25	
Quiet output minimum dynamic V <sub>OL</sub>		$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$ (N	ote)	2.5	-0.6	V
02		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$ (N	ote)	3.3	-0.8	
Quiet output minimum dynamic	V <sub>OHV</sub>	$V_{IH} = 1.8 \text{ V}, V_{IL} = 0 \text{ V}$ (N	ote)	1.8	1.5	
		$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$ (N	ote)	2.5	1.9	V
<b>3</b>		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$ (N	ote)	3.3	2.2	

Note: Parameter guaranteed by design.

### **Capacitive Characteristics (Ta = 25°C)**

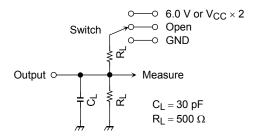
Characteristics	Symbol Test Condition			Tun	Unit
Characteristics	Symbol	rest Condition	V <sub>CC</sub> (V)	Тур.	Offic
Input capacitance	C <sub>IN</sub>	_	1.8, 2.5, 3.3	6	pF
Output capacitance	Co	_	1.8, 2.5, 3.3	7	pF
Power dissipation capacitance	C <sub>PD</sub>	f <sub>IN</sub> = 10 MHz (Note	1.8, 2.5, 3.3	20	pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/16 \text{ (per bit)}$ 

### **AC Test Circuit**



Parameter	Switch		
t <sub>pLH</sub> , t <sub>pHL</sub>	Open		
t <sub>pLZ</sub> , t <sub>pZL</sub>	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$		
t <sub>pHZ</sub> , t <sub>pZH</sub>	GND		

Figure 1

### **AC Waveform**

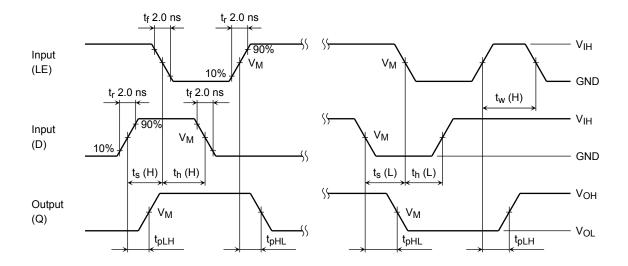


Figure 2  $t_{pLH}$ ,  $t_{pHL}$ ,  $t_w$ ,  $t_s$ ,  $t_h$ 

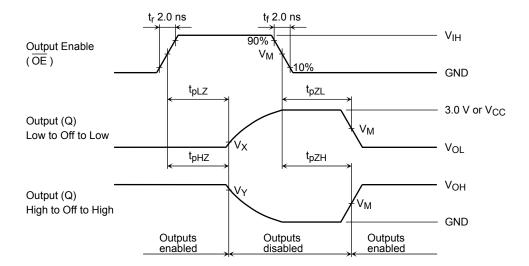


Figure 3  $t_{pLZ}, t_{pHZ}, t_{pZL}, t_{pZH}$ 

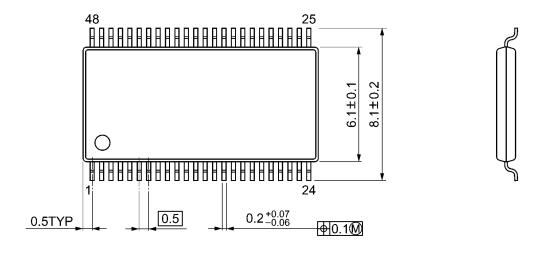
Symbol	Vcc						
Symbol	$3.3\pm0.3~\textrm{V}$	$2.5\pm0.2\textrm{V}$	1.8 V				
V <sub>IH</sub>	2.7 V	V <sub>CC</sub>	V <sub>CC</sub>				
$V_{M}$	1.5 V	V <sub>CC</sub> /2	V <sub>CC</sub> /2				
VX	V <sub>OL</sub> + 0.3 V	V <sub>OL</sub> + 0.15 V	V <sub>OL</sub> + 0.15 V				
VY	V <sub>OH</sub> – 0.3 V	V <sub>OH</sub> – 0.15 V	V <sub>OH</sub> – 0.15 V				

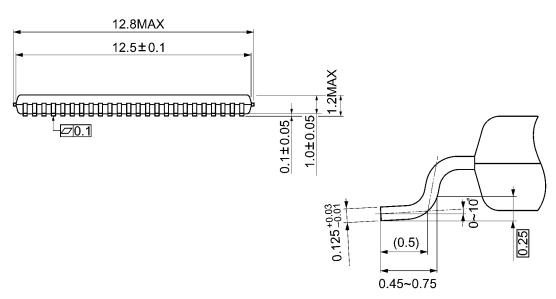
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# **Package Dimensions**

**TOSHIBA** 

TSSOP48-P-0061-0.50A Unit: mm





Weight: 0.25 g (typ.)

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